504655556 11/22/2017

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4702278

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HONG HUE TAT	11/20/2017
WILLIAM JOSEPH TAPIA	11/21/2017
BARRY ALLEN FETZER	11/22/2017
GARY E. GEORGESON	11/22/2017
MARTIN L. FREET	11/20/2017
JEFFREY G. THOMPSON	11/20/2017

RECEIVING PARTY DATA

Name:	THE BOEING COMPANY
Street Address:	100 N. RIVERSIDE PLAZA
City:	CHICAGO
State/Country:	ILLINOIS
Postal Code:	60606-2016

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15821668

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 972-385-8777

Email: ptonotifs@yeeiplaw.com

Correspondent Name: DUKE W. YEE

Address Line 1: YEE & ASSOCIATES, P.C.

Address Line 2: P.O. BOX 802333

Address Line 4: DALLAS, TEXAS 75380

ATTORNEY DOCKET NUMBER:	17-1765-US-NP
NAME OF SUBMITTER:	KELLY M. SULLIVAN
SIGNATURE:	/Kelly M. Sullivan/
DATE SIGNED:	11/22/2017
	This document serves as an Oath/Declaration (37 CFR 1.63).

PATENT

504655556 REEL: 044202 FRAME: 0971

Total Attachments: 18
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PATENT REEL: 044202 FRAME: 0972

DECLARATION (37 C.F.R. 1.63) FOR UTILITY PATENT APPLICATION USING AN APPLICATION DATA SHEET (37 C.F.R. 1.76) AND ASSIGNMENT

Title of Invention: THERMOGRAPHY INSPECTION FOR NEAR-SURFACE INCONSISTENCIES OF COMPOSITE STRUCTURES

As a below named and undersigned inventor, I hereby declare that:

Whereas, I ("ASSIGNOR") have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") disclosed in the above-identified patent application and further identified by the Boeing Docket Number provided above in the header of this document;

I am aware of the duty to disclose to the United States Patent and Trademark Office all information

known to me to be material to patentability as defined in 37 CFR Section 1.56.

Whereas, The Boeing Company (herein referred to as the "ASSIGNEE"), a corporation organized and existing under the laws of the State of Delaware, USA, having a place of business at 100 North Riverside Plaza, Chicago, Illinois 60606-1596, with a mailing address of 100 North Riverside Plaza, Chicago, Illinois 60606-1596, USA, desires to acquire, and I desire to grant to the ASSIGNEE, my entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, I hereby sell or have sold, assign or have assigned, and otherwise transfer or have transferred to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all provisionals, divisionals, continuations, continuations-in-part, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, I hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the same to be held and enjoyed by the ASSIGNEE, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by me had this Assignment not been made; and I agree to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in the ASSIGNEE, its successors, legal representatives, and assigns,

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(1) Legal Name of Inventor:	Hong Hue Tat		
Signature: Hoy	Ted	Date:	20-2017
(2) Legal Name of Inventor:	William Joseph Tapia		
Signature:		Date:	
(3) Legal Name of Inventor:	Barry Allen Fetzer		
Signature:		Date:	
(4) Legal Name of Inventor:	Gary E. Georgeson		
Cianaturo		Dottor	

(5) Legal Name of Inventor:	Martin L. Freet		
Signature:		Date:	
(6) Legal Name of Inventor:	Jeffrey G. Thompson		
Signature		Date:	

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Signature:		Date:
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Signature:	2	Date:
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Signature:		Date:
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Signature:		Date:

(5) Legal Name of Inventor:	Martin L. Freet		
Signature:		Date:	
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Signature		Date:	

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Signature:		Date:
(2) Legal Name of Inventor:	William Joseph Tapia	
Signature:		Date:
(3) Legal Name of Inventor:	Barry Allen Fetzer	
Signature: Barry	Allen Atju	Date: 11/27/17
(4) Legal Name of Inventor:		
Signature		Date

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Title of Invention: THERMOGRAPHY INSPECTION FOR NEAR-SURFACE INCONSISTENCIES OF COMPOSITE STRUCTURES

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the application, including the claims.

The above-identified application was made or authorized to be made by me.

As a below named and undersigned inventor, I hereby declare that:

I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR Section 1.56.

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Signature:	Jr	Date: /// 22/2017

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Signatura		Date	

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Signature: M L	2x	Date: 11/20/2017
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G.		D. /	

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Signature:		Date:	
(6) Legal Name of Inventor:	Jeffrey G. Thompson		
Signature: MA Juy	& Mupa		<u>-17</u>